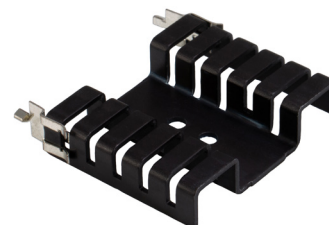


**MODEL:** HSS04-B20-P318 | **DESCRIPTION:** HEAT SINK

**FEATURES**

- TO-220 package
- solder pin
- aluminum alloy
- black anodized finish



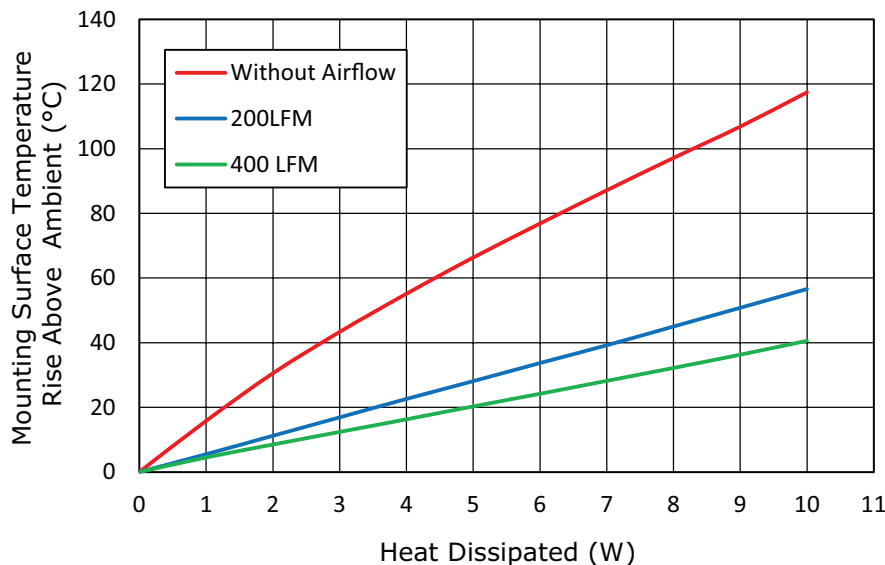
**MODEL**

HSS04-B20-P318	thermal resistance <sup>1</sup>				power dissipation <sup>1</sup>
	@ 75°C ΔT, nat conv [°C/W]	@ 1 W, nat conv [°C/W]	@ 1 W, 200 LFM [°C/W]	@ 1 W, 400 LFM [°C/W]	@ 75°C ΔT, nat conv [W]
	12.79	15.8	5.5	4.5	5.86

Note: 1. See performance curves for full thermal resistance details.

**PERFORMANCE CURVES**

Power (W)	Heatsink Temperature Rise Above Ambient (ΔT = T <sub>hs</sub> - T <sub>a</sub> ) [°C]		
	Natural Conv.	200 LFM	400 LFM
0	0	0	0
1	15.8	5.5	4.5
2	30.5	11.2	8.5
3	43.3	16.9	12.4
4	55.1	22.6	16.3
5	66.3	28.1	20.3
6	76.8	33.7	24.2
7	87.1	39.2	28.2
8	97.1	45.0	32.2
9	106.8	50.8	36.3
10	117.4	56.6	40.6

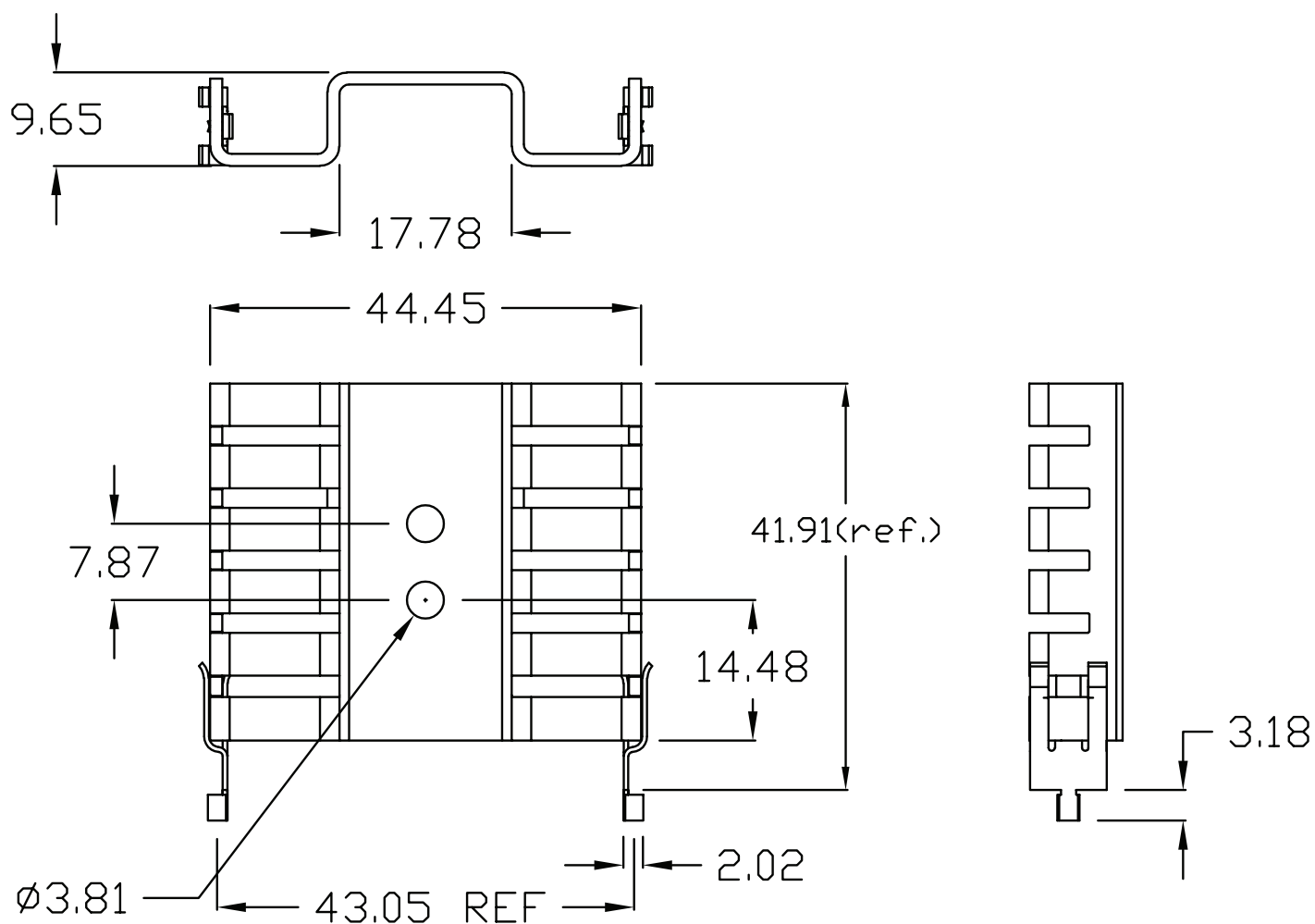


T<sub>hs</sub>: "hot spot" temperature measured on the heatsink  
 T<sub>a</sub>: ambient temperature

## MECHANICAL DRAWING

units: mm  
tolerance: ±0.3 mm

MATERIAL	AL 1050
FINISH	black anodized
THICKNESS	1.2 mm
PIN MATERIAL	phosphor bronze
PIN PLATING	2-3 μm tin
WEIGHT	8.0 g



## REVISION HISTORY

rev.	description	date
1.0	initial release	06/25/2021
1.01	logo, datasheet style update	08/05/2022

The revision history provided is for informational purposes only and is believed to be accurate.



CUI Devices offers a one (1) year limited warranty. Complete warranty information is listed on our website.

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